

1. General description

Passivated sensitive gate Silicon Controlled Rectifier (SCR) in a SOT428 (DPAK) surface mountable plastic package intended for use in applications requiring high bidirectional blocking voltage capability and high thermal cycling performance. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

2. Features and benefits

- · Direct interfacing with low power drivers and microcontrollers
- · High bidirectional blocking voltage capability
- High thermal cycling performance
- · Planar passivated for voltage ruggedness and reliability
- Surface mountable package
- Sensitive gate for logic level control

3. Applications

- · General purpose switching and phase control
- Ignition circuits, CDI for 2- and 3-wheelers
- Motor control e.g. small kitchen appliances
- Protection circuits for Switched-Mode Power Supplies (SMPS)
- Protection circuits in lighting ballasts

4. Quick reference data

Symbol	Parameter	Conditions	ſ	Min	Тур	Max	Unit
V _{RRM}	repetitive peak reverse voltage		-	•	-	650	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 100 °C; <u>Fig. 1</u>	-	•	-	7.5	A
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 100 °C; <u>Fig. 2;</u> <u>Fig. 3</u>	-	•	-	12	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; T _{j(init)} = 25 °C; t _p = 10 ms; <u>Fig. 4; Fig. 5</u>	-	-	-	90	A
		half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 8.3 \text{ ms}$	-	•	-	100	A
T _i	junction temperature		-	-	-	125	°C

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 8</u>	20	50	200	μA
Dynamic chara	ateristics					
dV _D /dt	rate of rise of off-state voltage	$\label{eq:DM} \begin{array}{l} V_{DM} = 436 \; V; \; T_{j} = 125 \; ^{\circ}\text{C}; \; R_{GK} = 100 \; \Omega; \\ (V_{DM} = 67\% \; of \; V_{DRM}); \; exponential \\ waveform; \; \underline{Fig. \; 13} \end{array}$	50	100	-	V/µs

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	[]	А - Ӈ- К
2	А	anode		Ġ sym037
3	G	gate		Synton
mb	A	mounting base; connected to anode	Ц <u>, 2</u> , 1 Ц <u>, 3</u> DPAK (SOT428)	

6. Ordering information

Table 3. Ordering information

Type number	Package				
	Name	Description	Version		
BT151S-650S	DPAK	plastic single-ended surface-mounted package (DPAK); 3 leads (one lead cropped)	SOT428		

7. Marking

Table 4. Marking codes	
Type number	Marking code
BT151S-650S	BT151S-650S

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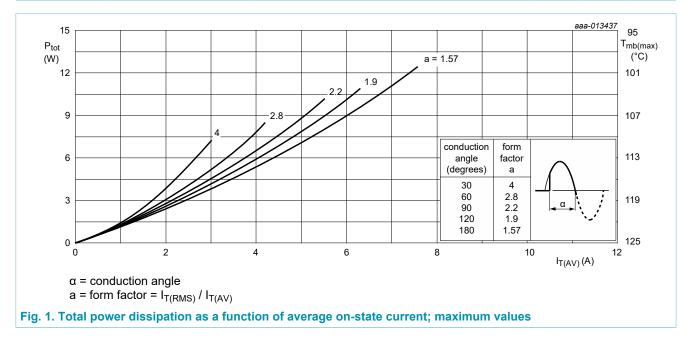


8. Limiting values

Table 5. Limiting values

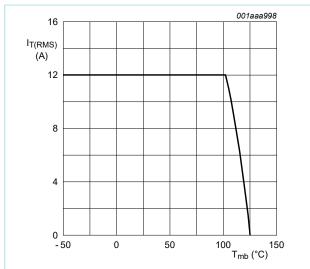
In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	650	V
V _{RRM}	repetitive peak reverse voltage		-	650	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 100 °C; <u>Fig. 1</u>	-	7.5	А
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 100 °C; <u>Fig. 2;</u> <u>Fig. 3</u>	-	12	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5	-	90	A
		half sine wave; T _{j(init)} = 25 °C; t _p = 8.3 ms	-	100	А
l ² t	I ² t for fusing	t _p = 10 ms; SIN	-	41	A²s
dl _T /dt	rate of rise of on-state current	I _G = 50 mA	-	50	A/µs
I _{GM}	peak gate current		-	2	А
V _{RGM}	peak reverse gate voltage		-	5	V
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		-	125	°C

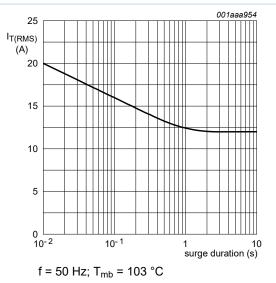


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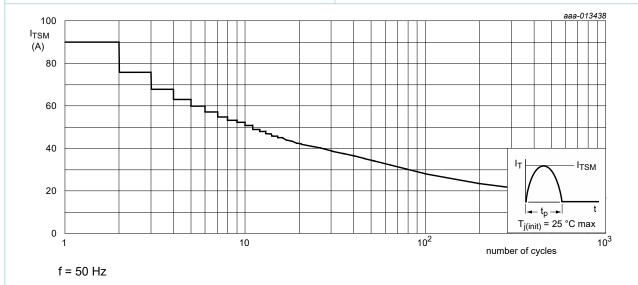
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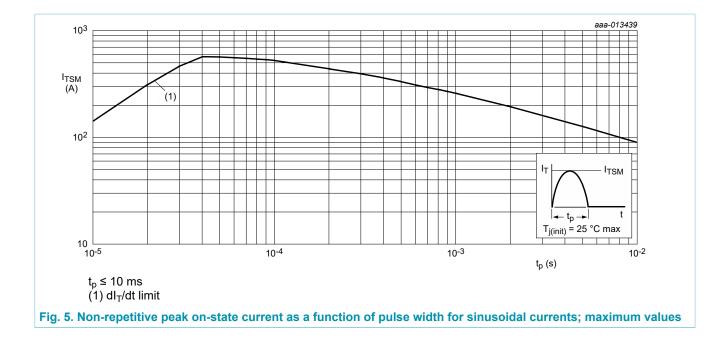






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9. Thermal characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 6</u>	-	-	2	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	mounted on an FR4 printed-circuit board; <u>Fig. 7</u>	-	7	-	K/W

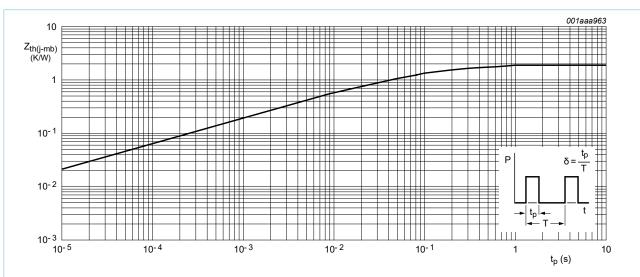
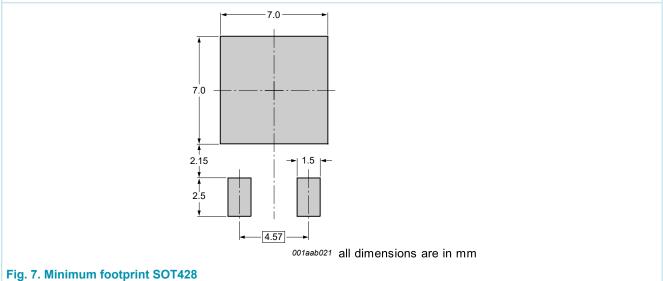
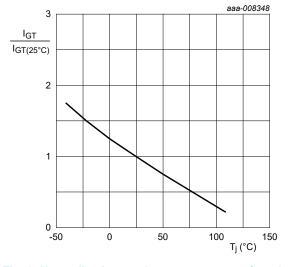


Fig. 6. Transient thermal impedance from junction to mounting base as as function of pulse width



10. Characteristics

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static chara	octeristics					
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 8</u>	20	50	200	μA
I _L	latching current	V _D = 12 V; I _G = 0.1 A; T _j = 25 °C; <u>Fig. 9</u>	-	0.4	10	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 10</u>	-	0.3	6	mA
V _T	on-state voltage	I _T = 20 A; T _j = 25 °C; <u>Fig. 11</u>	-	1.3	1.75	V
V _{GT}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; Fig. 12	-	0.6	1	V
		V _D = 650 V; I _T = 0.1 A; T _j = 110 °C; Fig. 12	0.1	0.2	-	V
ID	off-state current	V _D = 650 V; T _j = 125 °C	-	0.1	0.5	mA
I _R	reverse current	V _R = 650 V; T _j = 125 °C	-	0.1	0.5	mA
Dynamic ch	arateristics	· · · · · · · · · · · · · · · · · · ·				
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 436 V; T _j = 125 °C; R _{GK} = 100 Ω; (V _{DM} = 67% of V _{DRM}); exponential waveform; Fig. 13	50	100	-	V/µs



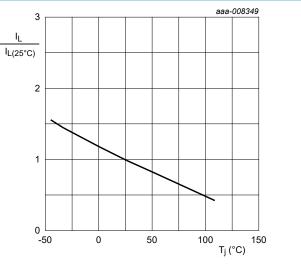
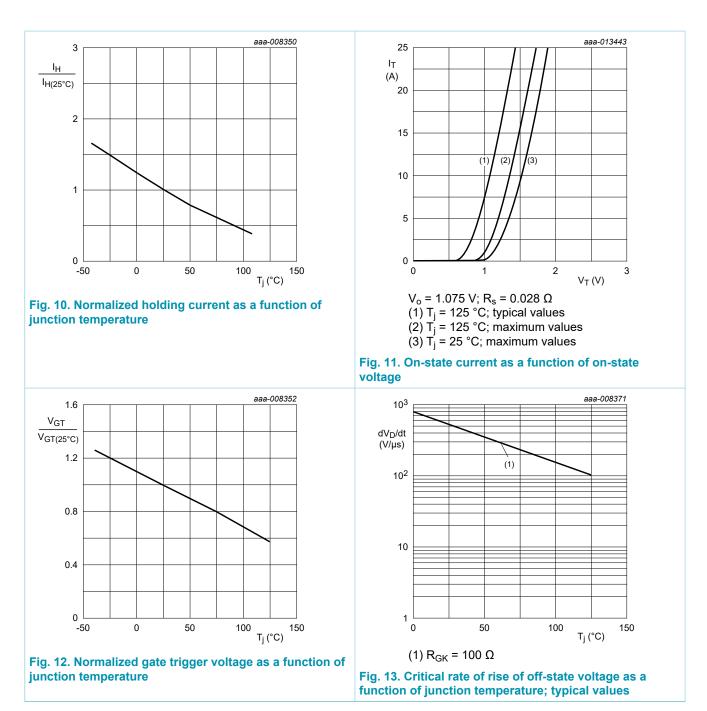


Fig. 8. Normalized gate trigger current as a function of junction temperature

Fig. 9. Normalized latching current as a function of junction temperature

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11. Package outline

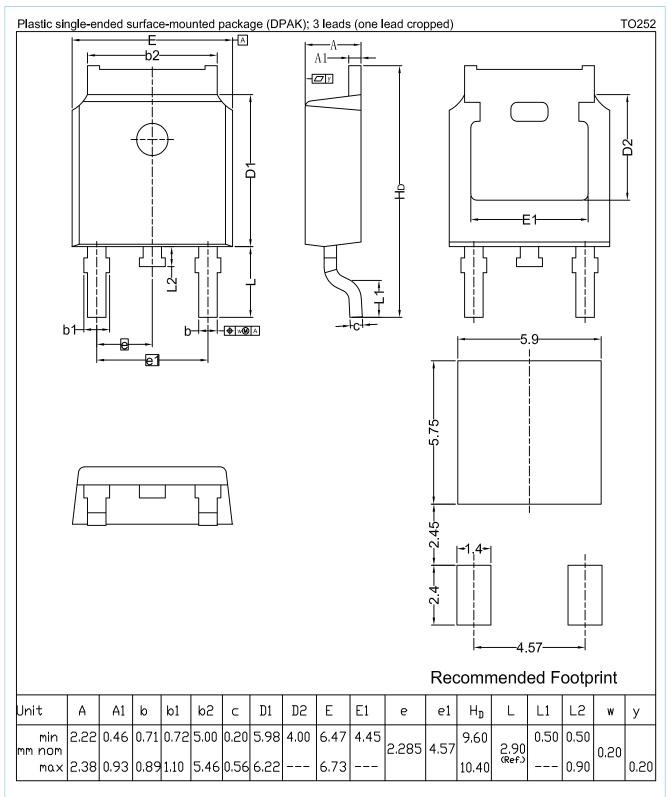


Fig. 14. Package outline DPAK (SOT428)

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12. Legal information

Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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